



Product Change Notification

Change Notification #: 116157 - 00
Change Title: Intel® Server System R1304SPOSHBNR, PCN 116157-00, Label, Update regulatory label to include India BIS mark implementation for PSU
Date of Publication: March 13, 2018

Key Characteristics of the Change:

Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	March 26, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R1304SPOSHBNR.

1. Update India BIS mark regulatory label implementation for PSU. Please see Figure-1 and Figure-2 below for details.



Figure-1 Old label

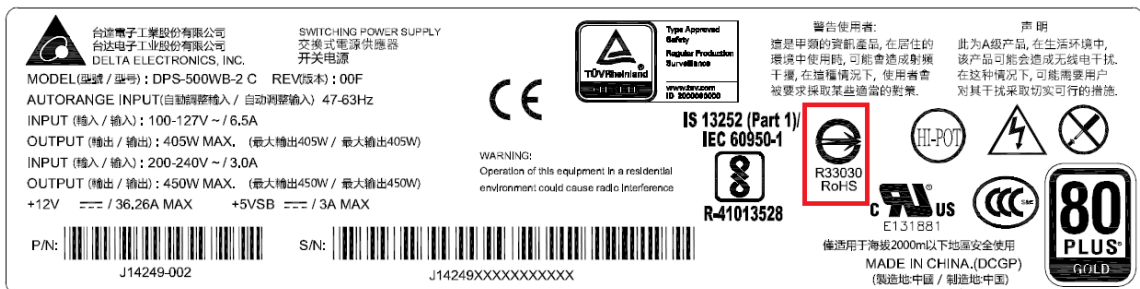


Figure-2 New label

2. Power Supply Unit model changed from DPS-500WB-1 A to DPS-500WB-2 C. The new model is identical in form factor and function to the previous one.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand these changes and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1304SPOSHBNR	951872	J49134-004	J49134-005

PCN Revision History:

Date of Revision:

March 13, 2018

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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